

---

**Dual Channel Bare-Bone USB Switch****■ FEATURES**

- 170mΩ High-Side MOSFET Switch.
- 0.5A Continuous Load Current.
- 40μA Quiescent Supply Current Per Channel.
- 3.2V to 5.5V Input Voltage Range.
- Under-Voltage Lockout.
- Current-Limit / Short Circuit Protection.
- Thermal Shutdown Protection under Over Current Condition.
- Under Voltage Lockout Ensures that Switch is off at Start Up.
- No Reverse Current when Power off.
- Available in SOT-23-5 Packages.

**■ APPLICATIONS**

- USB Power Management
- High-Side Power Protection Switch
- Hot Plug-In Power Supplies
- Battery-Charger Circuits
- Portable Application.
- Digital televisions
- Computer
- Multimedia
- Mobile Phones

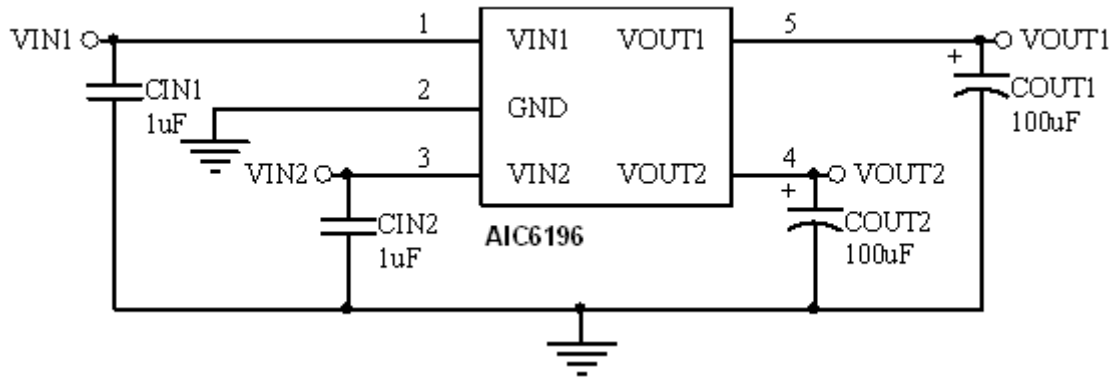
**■ DESCRIPTION**

The AIC6196 is a dual high-side power switch for self-powered and bus-powered Universal Serial Bus (USB) applications. Both high-side switches are MOSFET with 170mΩ  $R_{DS(ON)}$ , which meets USB voltage drop requirements for maximum transmission wire length.

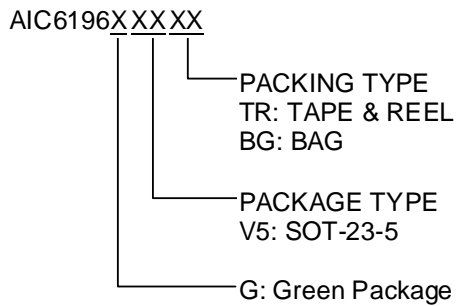
The protection includes current limiting with foldback, short circuit and thermal shutdown under overcurrent occurs.

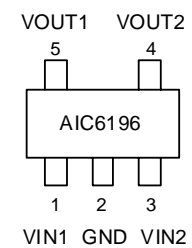
Guaranteed minimum output rise time limits inrush current during hot plug-in as well as minimizing EMI and prevents the voltage at upstream port from dropping excessively.

■ TYPICAL APPLICATION CIRCUIT



■ ORDERING INFORMATION



Package Type	Configuration
V5 (SOT-23-5)	

Example: AIC6196GV5TR

→ In SOT-23-5 Green package and TAPE & REEL packing.

- **Marking**

Part No.	Package Code	Package Type	Marking
AIC6196-x	GV5	SOT-23-5	6196G

**■ ABSOLUTE MAXIMUM RATINGS**

Supply Voltage ( $V_{IN}$ ).....6.0V  
 Operating Temperature Range.....-40°C~85°C  
 Junction Temperature.....125°C  
 Storage Temperature Range.....-65°C ~ 150°C  
 Lead Temperature (Soldering, 10sec) .....260°C  
 Thermal Resistance,  $\theta_{JC}$  (Junction to Case) SOT-23-5.....115°C/W  
 Thermal Resistance,  $\theta_{JA}$  (Junction to Ambient) SOT-23-5.....250°C/W  
 (Assume no Ambient Airflow, no Heatsink)

**Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.**

## ■ ELECTRICAL CHARACTERISTICS

( $V_{IN} = 5V$ ,  $C_{IN1} = C_{IN2} = 1 \mu F$ ,  $C_{OUT1} = C_{OUT2} = 100 \mu F$  (Note 2),  $T_A = 25^\circ C$ , unless otherwise specified.)

(Note 1)

PARAMETERS	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Input Voltage		3.2		5.5	V
Supply Current			40		$\mu A$
Current Limit Threshold		0.55	0.8	1	A
Output MOSFET Resistance			170		$m\Omega$
Output Turn-On Rise Time	$R_L = 10\Omega$ each Output		1000	2500	$\mu S$
Output Turn-Off Fall Time	$R_L = 10\Omega$ each Output		0.7	20	$\mu S$
Over Temperature Shutdown Threshold	$T_J$ Increasing		145		$^\circ C$
	$T_J$ Decreasing		125		
Under Voltage Lockout			2.5		V
Under Voltage Lockout Hysteresis			200		mV

Note1: Specifications are production tested at  $T_A = 25^\circ C$ . Specifications over the  $-40^\circ C$  to  $85^\circ C$  operating temperature range are assured by design, characterization and correlation with Statistical Quality Controls (SQC).

Note2: Electrolytic Capacitor is recommended for  $C_{OUT1}$  &  $C_{OUT2}$  capacitor.

**TYPICAL PERFORMANCE CHARACTERISTICS**

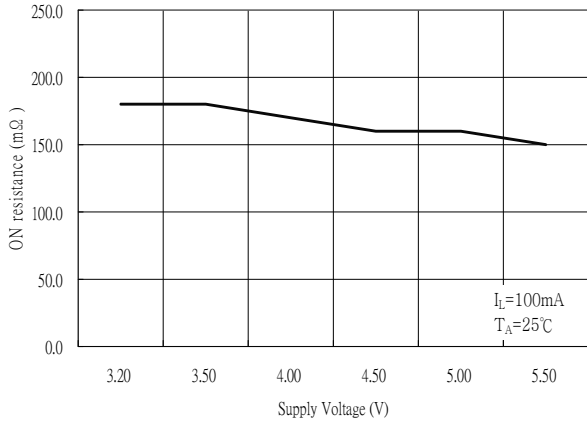


Fig. 1 ON Resistance vs. Supply voltage

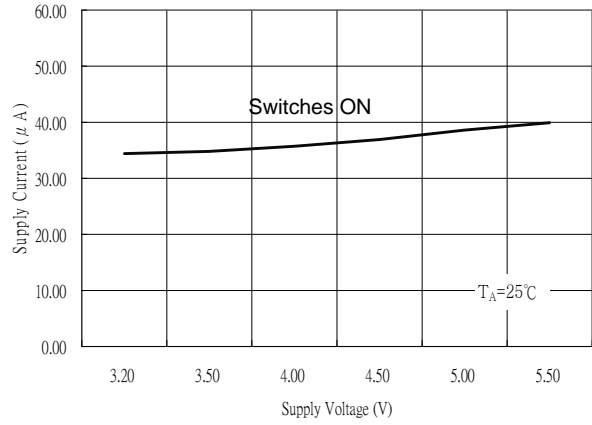


Fig. 2 On-State Supply Current vs. Supply Voltage

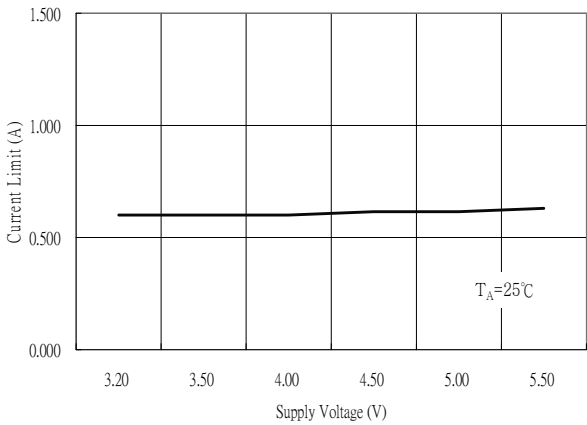


Fig. 3 Current Limit vs. Supply Voltage

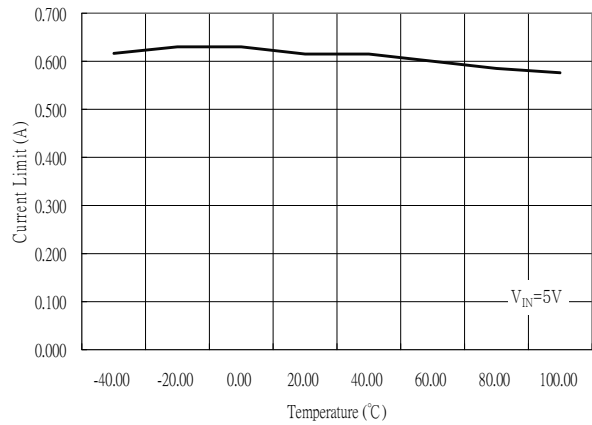


Fig. 4 Current Limit vs. Temperature

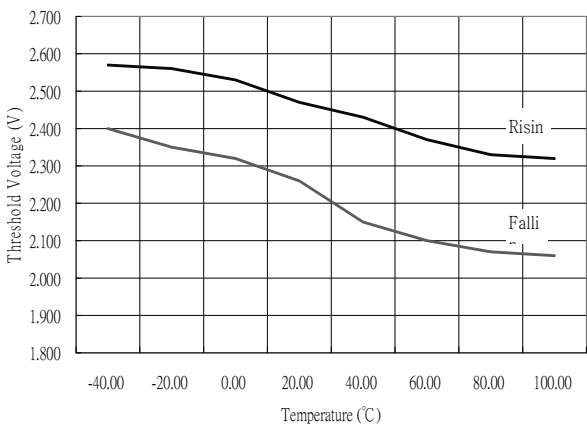


Fig. 5 UVLO Threshold Voltage vs. Temperature

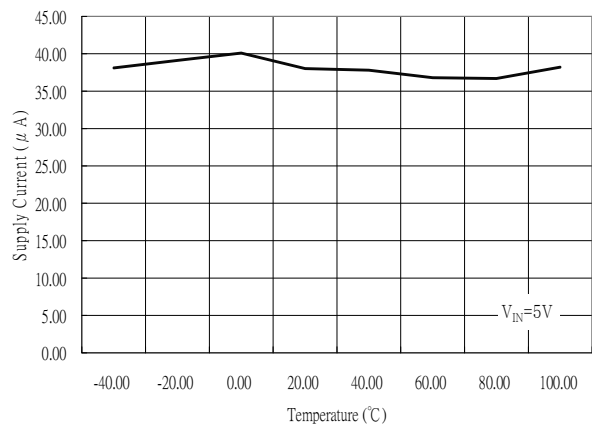


Fig. 6 Supply Current vs. Temperature

■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

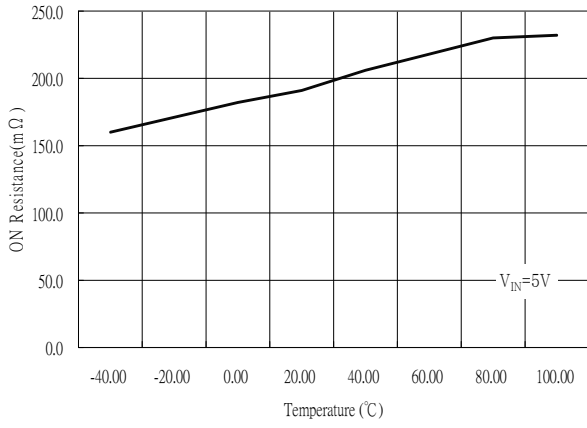
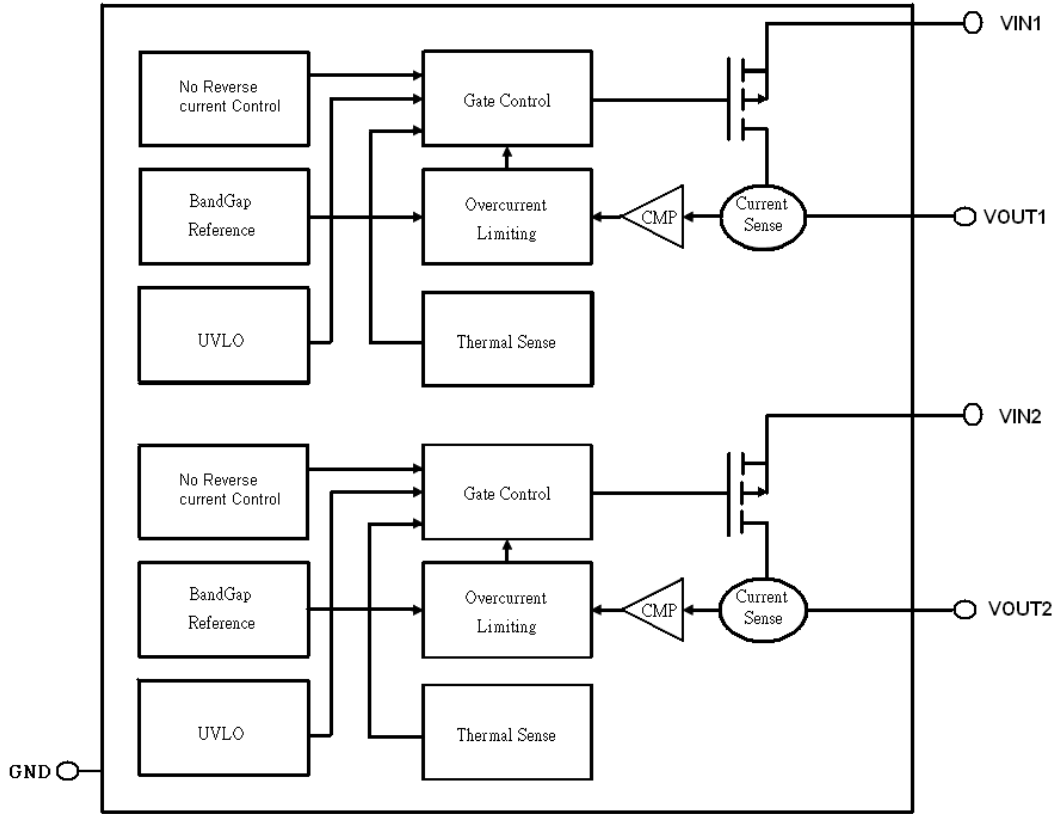


Fig. 7 ON resistance vs. Temperature

**■ BLOCK DIAGRAM**



**■ PIN DESCRIPTIONS**

PIN1 VIN1: Power supply input1.  
 PIN2 GND: Chip power ground.  
 PIN3 VIN2: Power supply input2.

PIN4 VOUT2: MOSFET switch output2.  
 PIN5 VOUT1: MOSFET switch output1.

## ■ APPLICATION INFORMATION

### ● Current Limit

Current limiting is invoked when the load exceeds the set over-current threshold. It protects the output MOSFET switches from damage resulting from undesirable short circuit conditions or excess inrush current, which is often encountered during hot plug-in.

### ● Thermal Shutdown

When junction temperature of AIC6196 exceeds 145°C for any reasons, the thermal shutdown function turns MOSFET switch off. A hysteresis of 20°C prevents the MOSFETs from turning back on until the chip temperature drops below 125°C. thermal shutdown circuit functions only when the switch is enabled.

### ● Under-voltage Lockout

UVLO prevents the MOSFET switch from turning on until input voltage exceeds 2.5V typically. After the switch turns on, if input voltage drops below 2.3V typically, UVLO shuts off the output MOSFET.

### ● Supply Filtering

A 0.1μF to 1μF bypass capacitor from IN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry. Input transients must not exceed the maximum  $V_{IN}$  voltage for a short duration.

### ● Transient Requirements

USB supports dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads

are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI and limit the inrush current during hot-attachment by filtering high-frequency signals.

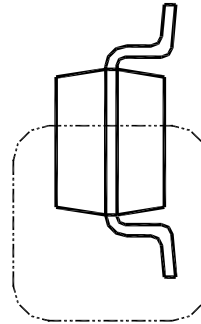
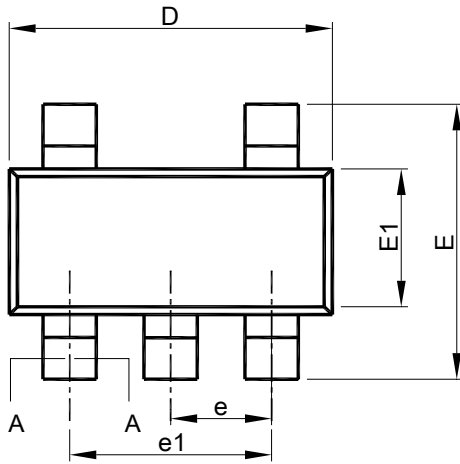
### ● Printed Circuit Layout

The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.

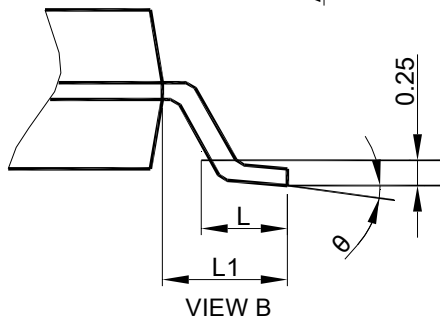
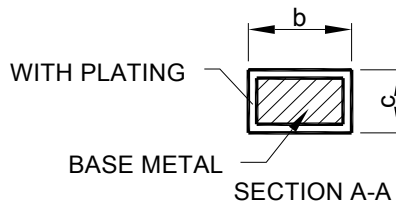
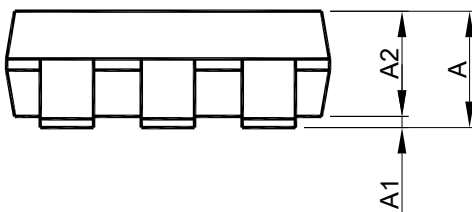


■ **PHYSICAL DIMENSIONS** (unit: mm)

● SOT-23-5



SEE VIEW B



GAUGE PLANE  
SEATING PLANE

SYMBOL	SOT-23-5	
	MILLIMETERS	
	MIN.	MAX.
A	0.95	1.45
A1	0.00	0.15
A2	0.90	1.30
b	0.30	0.50
c	0.08	0.22
D	2.80	3.00
E	2.60	3.00
E1	1.50	1.70
e	0.95 BSC	
e1	1.90 BSC	
L	0.30	0.60
L1	0.60 REF	
θ	0°	8°

Note : 1. Refer to JEDEC MO-178AA.

2. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion or gate burrs shall not exceed 10 mil per side.
3. Dimension "E1" does not include inter-lead flash or protrusions.
4. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.

**Note:**

Information provided by AIC is believed to be accurate and reliable. However, we cannot assume responsibility for use of any circuitry other than circuitry entirely embodied in an AIC product; nor for any infringement of patents or other rights of third parties that may result from its use. We reserve the right to change the circuitry and specifications without notice.

Life Support Policy: AIC does not authorize any AIC product for use in life support devices and/or systems. Life support devices or systems are devices or systems which, (i) are intended for surgical implant into the body or (ii) support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.